Specification

Drawing No.	UKY1C-H2-25AAA-00[43] 1/11
Issued Date.	2025/06/27

TO:

Note: Part numbers may be revised in the event of any specifications change.

Product Name	Quartz Crystal
Product Model	CX3225CA
Frequency	16000 kHz
Customer Part Number	-
Customer Specification Number	-
KYOCERA Part Number	CX3225CA16000H0HPSHH
Remarks Pb-Free, RoHS Compliant, MSL 1, AEC-Q200 Compliant	

Customer Acceptance

Accept Signature	Approved Date	
	Department	
	Person in charge	

Seller
KYOCERA Corporation
Corporate Electronic Components Group
Electronic Components Sales Division
6 Takeda Tobadono-cho, Fushimi-ku, Kyoto
612-8501 Japan
TEL. No. 075-604-3500
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Manufacturer

Corporate Electronic Components Group
Electronic Devices Division

Design Department	Quality Assurance	Approved by	Checked by	Checked by	Issued by
KYOCERA Corporation Crystal Components Application Engineering Section 2 Electronic Devices Division Corporate Electronic Components Group	-	-	-	-	-

Revision History

Rev.No.	Description of revise	Date	Approved by	Examination by	Issued by
00	First Edition	2025/06/27	-	-	-

1. APPLICATION

This specification sheet is applied to quartz crystal "CX3225CA16000H0HPSHH"

2. KYOCERA PART NUMBER

CX3225CA16000H0HPSHH

3. RATINGS

Items	SYMB.	Rating	Unit	Remarks
Operating Temperature	Topr	-40 to +85	°C	
Storage Temperature Range	Tstg	-40 to +150	°C	

4. CHARACTERISTICS

ELECTRICAL CHARACTERISTICS

Items	Electrical Specification					Test Condition	Remarks
	SYMB.	Min.	Typ.	Max.	Unit		
Mode of Vibration			Fundamental				
Nominal Frequency	F0		16		MHz		
Nominal Temperature	T_{NOM}		+25		°C		
Load Capacitance	CL		12		pF		
Frequency Tolerance	df/F	-20		+20	PPM	+25±3°C	See Measurement Condition
Frequency Temperature Characteristics	df/F	-50		+50		-40 to +85°C	Based on an oscillation frequency at + 25 °C
Frequency Aging Rate		-5.0		+5.0		1st year	+25±3°C
Equivalent Series Resistance	ESR			120	Ω		See Measurement Condition
Drive Level	Pd	0.01		200	μW		
Insulation Resistance	IR	500			MΩ	100V (DC)	

5. Measurement Condition

5.1 Frequency measurement

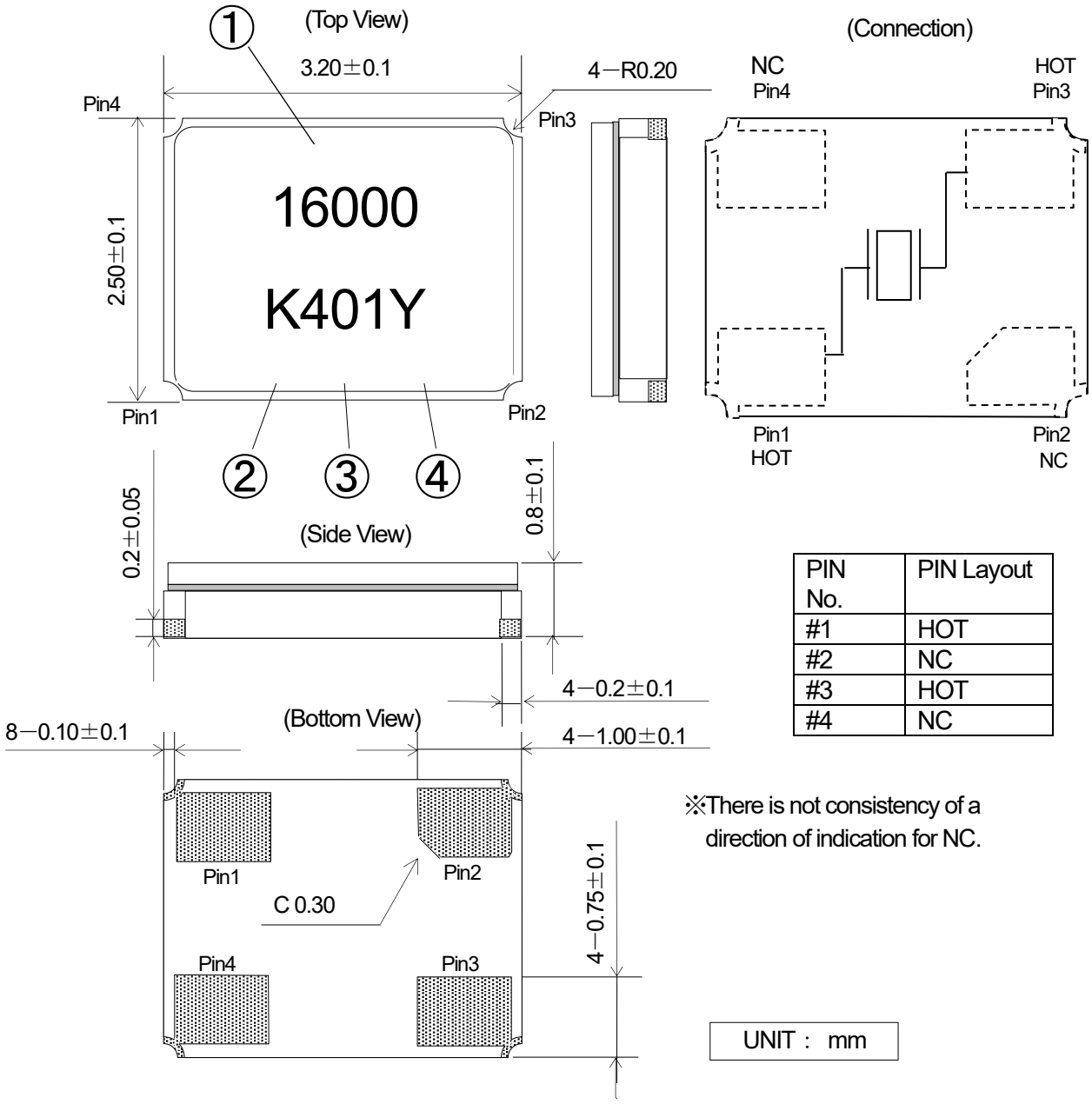
Measuring instrument : IEC PI-Network Test Fixture
Load Capacitance : 12pF
Drive Level : 10μW

5.2 Equivalent series resistance (ESR) measurement

Measuring instrument : IEC PI-Network Test Fixture
Load Capacitance : Series
Drive Level : 10μW

6. APPEARANCES, PHYSICAL DIMENSION

OUTLINE DIMENSION (not to scale)



PIN No.	PIN Layout
#1	HOT
#2	NC
#3	HOT
#4	NC

※There is not consistency of a direction of indication for NC.

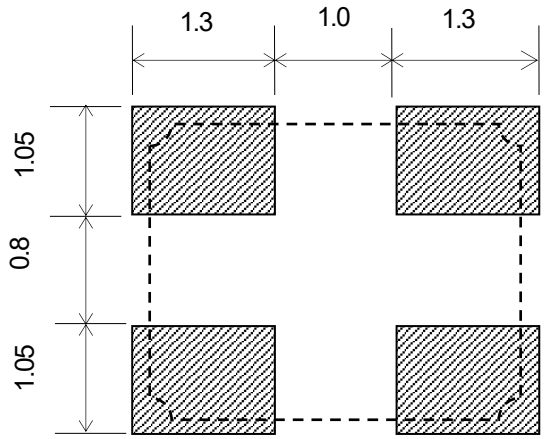
UNIT : mm

MARKING

1 Nominal Frequency	Move the number of maximum indication beams of the frequency to five digits, and omit less than kHz.
2 Identification	
3 Date Code	Year…LAST 1 DIGIT of YEAR AND WEEK (Ex) Jan. 1, 2024 → 401
4 Manufacturing Location	Y…Japan (Yamagata) V…Vietnam

※The font of marking is reference.

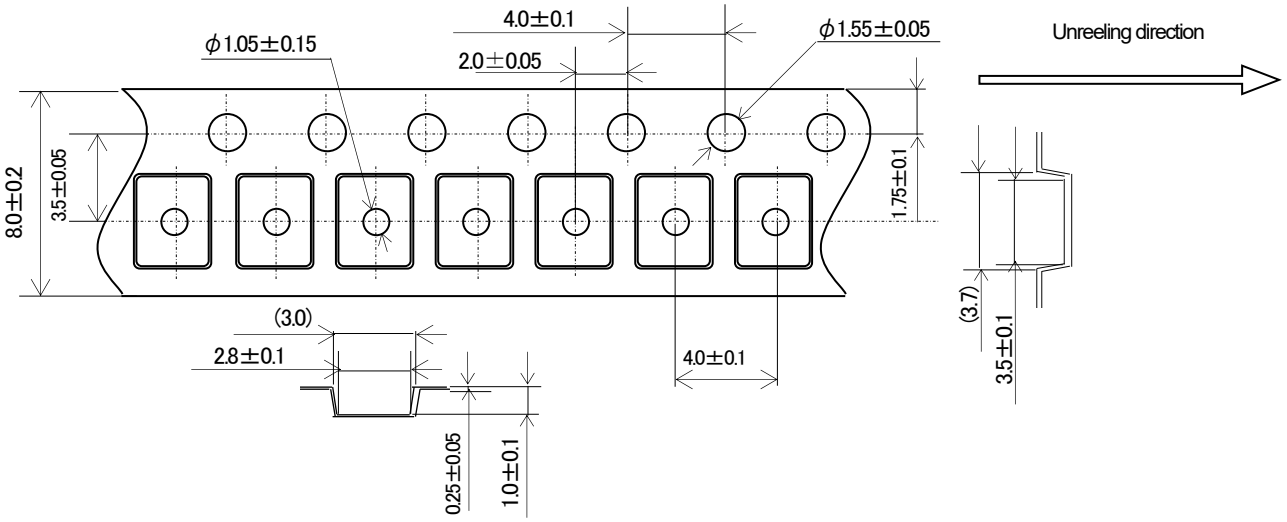
7. RECOMMENDED LAND PATTERN (not to scale)



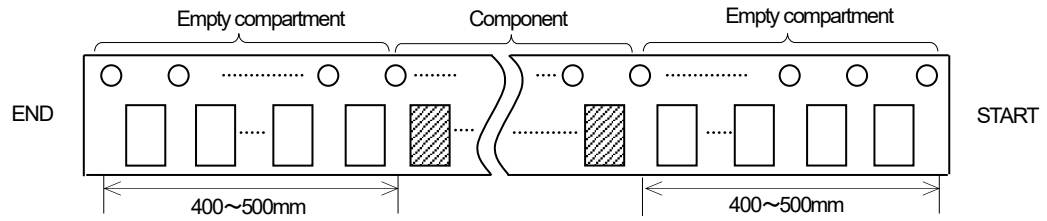
UNIT : mm

8.TAPING & REEL

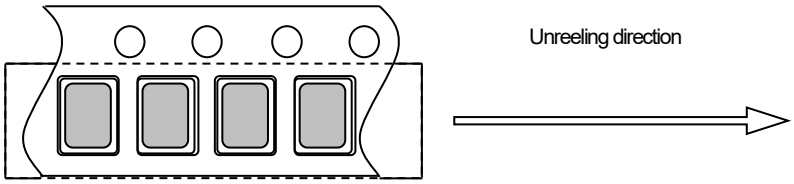
8-1.Dimensions



8-2.Leader and trailer tape

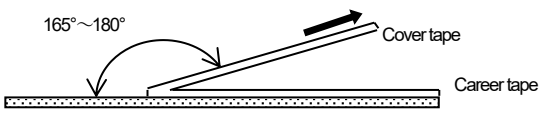


8-3.Direction (The direction shall be seen from the top cover tape side)

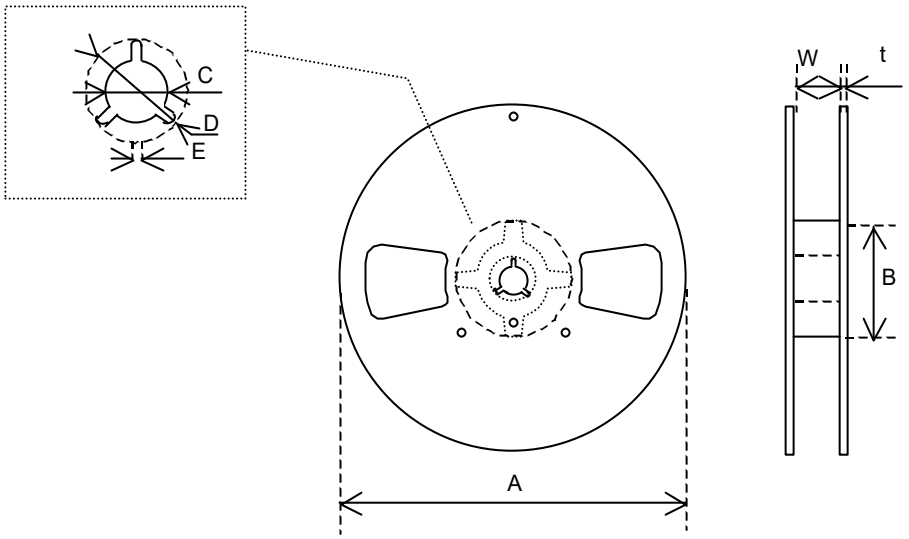


8-4.Specification

1. Material of the carrier tape is either polystyrene or A—PET (ESD).
2. Material of the cover tape is PET/PE (ESD).
3. The seal tape shall not cover the sprocket holes and not protrude from the carrier tape.
4. Tensile strength of carrier tape: 10N or more.
5. The R of the corner of each cavity is 0.2RMAX.
6. The alignment between centers of the cavity and sprocket hole shall be 0.05mm or less.
7. Peeling force of cover tape: 0.1 to 1.0N.
8. The component will fall out naturally when cover tape is removed and set upside down.
9. The marking on parts is not fixed its direction, its electrical characteristic is equal.



8-5.Reel specifications



(Nonconductor type Reel)

Φ180 Reel (3000pcs max.)

	A	B	C	D
Dimension	φ180 +0/-1.5	φ60 +1/-0	φ13±0.2	φ21±0.8
Symbol	E	W	t	
Dimension	2.0±0.5	9±1	2.0±0.5	

(Unit : mm)

9.Enviromental requirements

(Reference: AEC-Q200 Rev. D. The solder used by examination is hereafter set to Sn-3Ag-0.5Cu.)

After following test, frequency shall not change more than ±10×10^{-6} and CI, ±20% or 5Ω.

No	Stress	Reference	Additional Requirements
9.1	High Temperature Exposure (Storage)	MIL-STD-202 Method 108	1000 hrs. at rated operating temperature (e.g. 85°C part can be stored for 1000 hours at 85°C. Same applies for 125°C). Unpowered. Measurement at 24±4 hours after test conclusion.
9.2	Temperature Cycling	JESD22 Method JA-104	1000 cycles (-40°C to 125°C) Note: If 85°C parts the 1000 cycles will be at that temperature rating. Measurement at 24±4 hours after test conclusion. 30min maximum dwell time at each temperature extreme. 1 min. maximum transition time.
9.3	Biased Humidity	MIL-STD- 202 Method 103	1000 hours 85°C/85%RH. Rated VDD applied with 1MΩ and inverter in parallel, 2X crystal CL capacitors between each crystal leg and GND. Measurement at 24±4 hours after test conclusion.
9.4	Operational Life	MIL-STD- 202 Method 108	Note: 1000 hours @ 125°C. If 85°C part will be tested at that temperature. Rated VDD applied with 1 MΩ and inverter in parallel, 2X crystal CL capacitors between each crystal leg and GND. Measurement at 24±4 hours after test conclusion.
9.5	Resistance to Solvents	MIL-STD- 202 Method 215	Note: Also aqueous wash chemical - OKEM clean or equivalent. Do not use banned solvents.
9.6	Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213. Condition C
9.7	Vibration	MIL-STD-202 Method 204	5g's for 20 minutes 12 cycles each of 3 orientations. Note: Use 8"X5" PCB .031" thick with 7 secure points on one 8" side and 2 secure points on corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz.
9.8	Resistance to Soldering Heat	MIL-STD-202 Method 210	Condition B. No pre-heat of samples. Solder temp: 260±5℃, Soaking time: 10±1sec, Number of tests: 1 Note: The electrodes are immersed in molten solder to a level that covers the electrodes of the component.
9.9	Solder ability	J-STD-002	Evaluate the solderability of external electrodes of components. Conditions (SMD): Method D category 3, Solder temp: 260±5°C, Soaking time: 30+5/-0sec.
9.10	Board Flex	AEC Q200-005	Maintain a bend depth of 2 mm for 60 seconds. Note: Use FR4 substrate with external dimensions of 100 x 40 mm and thickness of 1.6±02 mm.
9.11	Terminal Strength (SMD)	AEC Q200-006	A pushing force of 17.7 N perpendicular to the side of the specimen on the test substrate is applied for 60 seconds

10. Soldering condition

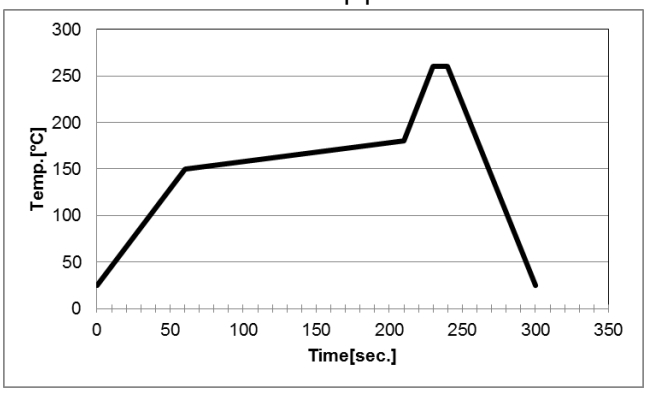
1.) Material of solder
Kind … lead free solder paste
Melting point … +220±5°C

2.) Reflow temp.profile

	Temp [°C]	Time[sec]
Preheating	+150 to +180	150 (typ.)
Peak	+260±5	10 (max.)
Total	—	300 (max.)

3.) Hand Soldering +350°C 3 sec MAX
4.) Reflow Times 2 times

Reflow temp.profile



11. Cautions for use

(1)Soldering upon mounting
There is a possibility to influence product characteristics when Solder paste or conductive glue comes in contact with product lid or surface.

(2)When using mounting machine
Please minimize the shock when using mounting machine to avoid any excess stress to the product.

(3)Conformity of a circuit
We strongly recommend to make sure that Negative resistance (Gain) of IC is designed to be 10 times the ESR (Equivalent Series Resistance) of crystal unit.

(4)After making the Quartz Crystal mount on a printed circuit board ,if it is required to divide the printed circuit board into another one, use it with attentive confirmation so that a warp cased by this dividing might not affect any damage. When designing a printed circuit board as well as handling the mounting As much as possible. The quartz crystal shall be passed through the reflow furnace. Then it shall be subjected to standard atmospheric conditions, after which cleaning shall be made.

12. Storage conditions

Please store product in below conditions, and use within 6 months.
Temperature +18 to +30°C, and Humidity of 20 to 70 % in the packaging condition.

12. Manufacturing location

Kyocera Corporation Yamagata Higashine plant / Japan (Yamagata)
Kyocera Vietnam Co., LTD. / Vietnam

14. Quality Assurance

To be guaranteed by Kyocera Corporation Yamagata Higashine plant Quality Assurance Division

15. Quality guarantee

In case when Kyocera Corporation rooted failure occurred within 1year after its delivery, substitute product will be arranged based on discussion. Quality guarantee of product after 1year of its delivery is waivered.

16. Others

In case of any questions or opinions regarding the Specification, please have it in written manner within 45 days after issued date.